

HMC849ALP4CE

v00.1013



HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 6 GHz

Typical Applications

The HMC849ALP4CE is ideal for:

- Cellular/4G Infrastructure
- WiMAX, WiBro & Fixed Wireless
- Automotive Telematics
- Mobile Radio
- Test Equipment

Features

High Isolation: up to 60 dB

Single Positive Control: 0/+3V to +5V

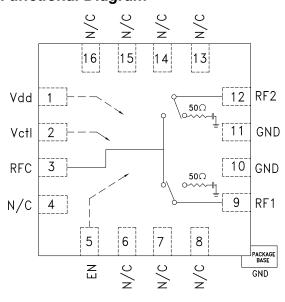
High Input IP3: +52 dBm

Non-Reflective Design

"All Off" State

16 Lead 4x4 mm QFN Package: 16 mm²

Functional Diagram



General Description

The HMC849ALP4CE is a high isolation non-reflective DC to 6 GHz GaAs pHEMT SPDT switch in a low cost leadless surface mount package. The switch is ideal for cellular/WiMAX/4G Infrastructure applications yielding up to 60 dB isolation, low 0.8 dB insertion loss and +52 dBm input IP3. Power handling is excellent up through the 5 - 6 GHz WiMAX band with the switch offering a P1dB compression point of +31 dBm. On-chip circuitry allows a single positive voltage control of 0/+3V or 0/+5V at very low DC currents. An enable input (EN) set to logic high will put the switch in an "all off" state.

Electrical Specifications, T_{Δ} = +25 °C, Vctl = 0/Vdd, Vdd = +3V to +5V, 50 Ohm System

Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 2.0 GHz 2.0 - 4.0 GHz 4.0 - 6.0 GHz		0.9 1.0 1.8	1.3 1.5 2.5	dB dB
Isolation (RFC to RF1/RF2)	DC - 2.0 GHz 2.0 - 4.0 GHz 4.0 - 6.0 GHz	53 48 35	60 56 50		dB dB
Return Loss (On State)	DC - 4.0 GHz 4.0 - 6.0 GHz		17 14		dB dB
Return Loss (Off State)	DC - 6.0 GHz		15		dB
Input Power for 1 dB Compression +3V +5V	0.35 - 6.0 GHz	24 30	27 33		dBm dBm
Input Third Order Intercept (Two-Tone Input Power = +10 dBm Each Tone)	DC - 6.0 GHz		52		dBm
Switching Speed tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)	DC - 6.0 GHz		60 150	600	ns ns

HMC849A* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS -

View a parametric search of comparable parts.

EVALUATION KITS

· HMC849ALP4C Evaluation Board

DOCUMENTATION

Data Sheet

• HMC849A Data Sheet

TOOLS AND SIMULATIONS

HMC849A S-Parameter

REFERENCE MATERIALS 🖵

Quality Documentation

- HMC Legacy PDN: PCN130060
- Semiconductor Qualification Test Report: PHEMT-J (QTR: 2013-00285)

DESIGN RESOURCES 🖵

- HMC849A Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

DISCUSSIONS

View all HMC849A EngineerZone Discussions.

SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK 🖳

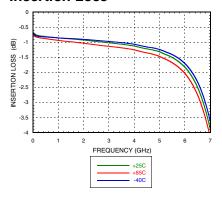
Submit feedback for this data sheet.



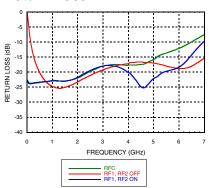


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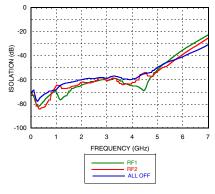
Insertion Loss



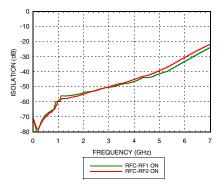
Return Loss [1]



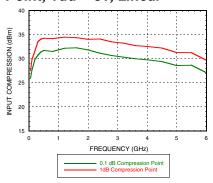
Isolation Between Ports RFC and RF1 / RF2



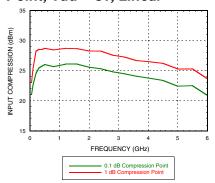
Isolation Between Ports RF1 and RF2



0.1 and 1 dB Input Compression Point, Vdd = 5V, Linear



0.1 and 1 dB Input Compression Point, Vdd = 3V, Linear



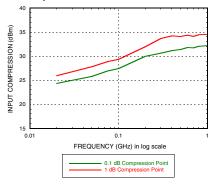
[1] RFC is reflective in "all off" state.



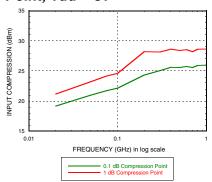


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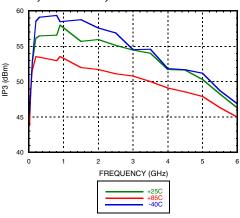
0.1 and 1 dB Input Compression Point, Vdd = 5V



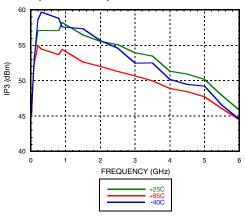
0.1 and 1 dB Input Compression Point, Vdd = 3V



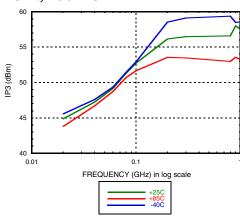
Input Third Order Intercept Point, Vdd = 5V, Linear



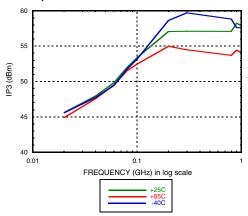
Input Third Order Intercept Point, Vdd = 3V, Linear



Input Third Order Intercept Point, Vdd = 5V



Input Third Order Intercept Point, Vdd = 3V







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Absolute Maximum Ratings

Bias Voltage (Vdd)	7V
Control Voltage (Vctl, EN)	-1V to Vdd +1V
RF Input Power * Through Path 3V/5V	31 / 33 dBm
Termination Path 3V/5V	26.5 dBm
Channel Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 14.9 mW/°C for through path, and 6.9 mW/°C for termination path above 85 °C) Through Path	0.969 W
Termination Path	0.451 W
Thermal Resistance (channel to package bottom) Through Path Termination Path	67.1 °C/W 144.2°C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

^{*} The RF input power is quite lower than the breakdown power levels. Hence, the only concern with this product is the thermal limit.



Bias Voltage & Current

Vdd (V)	ldd (Typ.) (mA)
3	1.2
5	1.3

Digital Control Voltages

State	Bias Condition
Low	0 to +0.8 Vdc @ <1 μA Typical
High	+2.0 to +5.0 Vdc @ 40 μA Typical

Truth Table

Control Input		Signal Path State		
Vctl	EN	RFC - RF1	RFC - RF2	
Low	Low	OFF	ON	
High	Low	ON	OFF	
Low	High	OFF	OFF	
High	High	OFF	OFF	

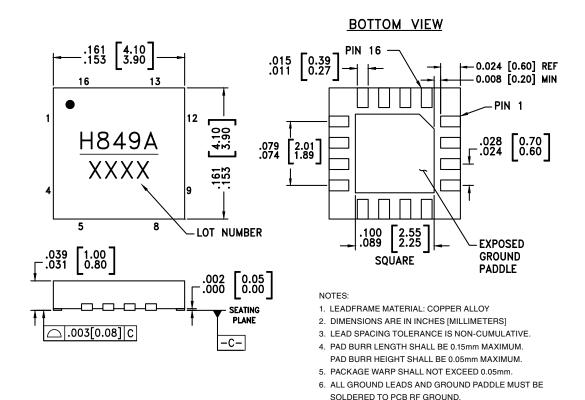




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7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED

Outline Drawing



Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [1]
HMC849ALP4CE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>H849A</u> XXXX

LAND PATTERN.

^{[1] 4-}Digit lot number XXXX

^[2] Max peak reflow temperature of 260 °C



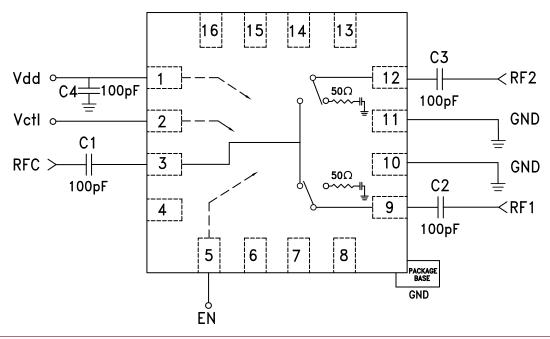


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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	Vdd	Supply Voltage.	
2	Vctl	Control input. See truth and control voltage tables.	Vctl 134K 500 =
3, 9, 12	RFC, RF1, RF2	These pins are DC coupled and matched to 50 Ohms. Blocking capacitors are required.	
4, 6, 7, 8, 13, 14, 15, 16	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
5	EN	Enable. See truth and control voltage tables.	500 134K
10, 11	GND	Package bottom must also be connected to PCB RF ground.	Ç GND ≡

Application Circuit

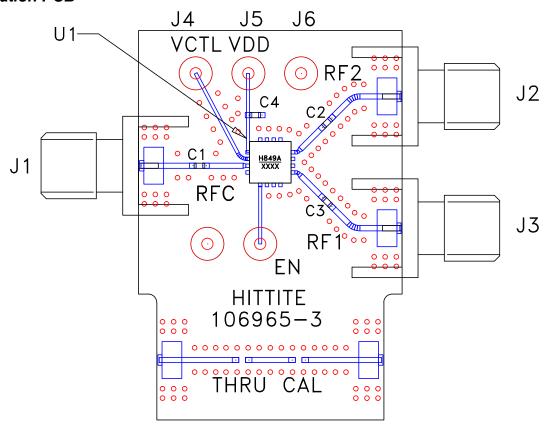






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Evaluation PCB



List of Materials for Evaluation PCB EV1HMC849ALP4C [1]

Item	Description
J1 - J3	PC Mount SMA RF Connector
J4 - J8	DC Pin
C1 - C4	100 pF Capacitor, 0402 Pkg.
U1	HMC849ALP4CE SPDT Switch
PCB [2]	106965 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25FR

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 Ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.







ANALOGDEVICES

HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 6 GHz

Notes: